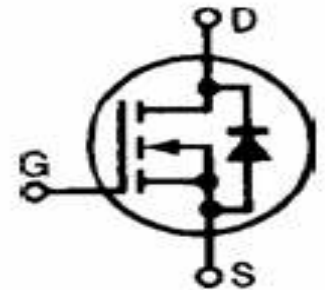
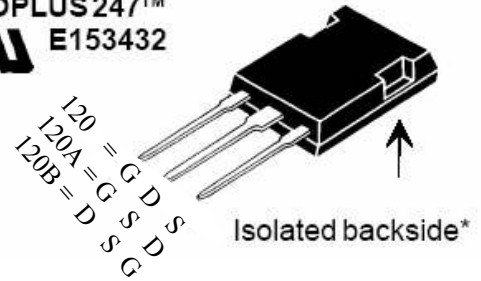


N-Channel Enhancement Mode Switch Mode RF MOSFET
 Low Capacitance Z-MOS™ MOSFET Process
 Optimized for RF Operation
 Ideal for Class C, D, & E Applications

$V_{DSS} = 1200 \text{ V}$
 $I_{D25} = 8.0 \text{ A}$
 $R_{DS(on)} \leq 1.5 \Omega$
 $P_{DC} = 250 \text{ W}$

Symbol	Test Conditions	Maximum Ratings	
V_{DSS}	$T_J = 25^\circ\text{C}$ to 150°C	1200	V
V_{DGR}	$T_J = 25^\circ\text{C}$ to 150°C ; $R_{GS} = 1 \text{ M}\Omega$	1200	V
V_{GS}	Continuous	± 20	V
V_{GSM}	Transient	± 30	V
I_{D25}	$T_c = 25^\circ\text{C}$	8	A
I_{DM}	$T_c = 25^\circ\text{C}$, pulse width limited by T_{JM}	40	A
I_{AR}	$T_c = 25^\circ\text{C}$	8	A
E_{AR}	$T_c = 25^\circ\text{C}$	TBD	mJ
dv/dt	$I_S \leq I_{DM}$, $di/dt \leq 100 \text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ\text{C}$, $R_G = 0.2 \Omega$	5	V/ns
	$I_S = 0$	>200	V/ns
P_{DC}		250	W
P_{DHS}	$T_c = 25^\circ\text{C}$, Derate $4.4 \text{ W}/^\circ\text{C}$ above 25°C	180	W
P_{DAMB}	$T_c = 25^\circ\text{C}$	3.0	W
R_{thJC}		0.60	C/W
R_{thJHS}		0.85	C/W

ISOPLUS 247™
 E153432



Features

- Isolated Substrate
 - high isolation voltage (>2500V)
 - excellent thermal transfer
 - Increased temperature and power cycling capability
- IXYS advanced Z-MOS process
- Low gate charge and capacitances
 - easier to drive
 - faster switching
- Low $R_{DS(on)}$
- Very low insertion inductance (<2nH)
- No beryllium oxide (BeO) or other hazardous materials

Advantages

- High Performance RF Z-MOS™
- Optimized for RF and high speed switching at frequencies to 100MHz
- Common Source RF Package
- Easy to mount—no insulators needed

		min.	typ.	max.	
V_{DSS}	$V_{GS} = 0 \text{ V}$, $I_D = 4 \text{ ma}$	1200			V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	4	4.9	6	V
I_{GSS}	$V_{GS} = \pm 20 \text{ V}_{DC}$, $V_{DS} = 0$			± 100	nA
I_{DSS}	$V_{DS} = 0.8 V_{DSS}$ $V_{GS} = 0$	$T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$		50	μA
				1	mA
$R_{DS(on)}$	$V_{GS} = 15 \text{ V}$, $I_D = 0.5 I_{D25}$ Pulse test, $t \leq 300 \mu\text{s}$, duty cycle $d \leq 2\%$		1.4		Ω
g_{fs}	$V_{DS} = 20 \text{ V}$, $I_D = 0.5 I_{D25}$, pulse test	4	5.5	6.5	S
T_J		-55		+175	$^\circ\text{C}$
T_{JM}			175		$^\circ\text{C}$
T_{stg}		-55		+ 175	$^\circ\text{C}$
T_L	1.6mm(0.063 in) from case for 10 s		300		$^\circ\text{C}$
Weight			3.5		g



IXZR08N120 & IXZR08N120A/B
Z-MOS RF Power MOSFET

Symbol	Test Conditions	Characteristic Values		
		(T _J = 25°C unless otherwise specified)		
		min.	typ.	max.
R _G			0.3	Ω
C _{iss}			1900	pF
C _{oss}	V _{GS} = 0 V, V _{DS} = 0.8 V _{DSS(max)} , f = 1 MHz		86	pF
C _{rss}			11	pF
C _{stray}	Back Metal to any Pin		33	pF
T _{d(on)}			4	ns
T _{on}	V _{GS} = 15 V, V _{DS} = 0.8 V _{DSS} I _D = 0.5 I _{DM}		5	ns
T _{d(off)}	R _G = 0.2 Ω (External)		4	ns
T _{off}			6	ns
Q _{g(on)}			39	nC
Q _{gs}	V _{GS} = 10 V, V _{DS} = 0.5 V _{DSS} I _D = 0.5 I _{D25} I _G = 3mA		11	nC
Q _{gd}			19	nC

Source-Drain Diode		Characteristic Values		
		(T _J = 25°C unless otherwise specified)		
Symbol	Test Conditions	min.	typ.	max.
I _S	V _{GS} = 0 V			8 A
I _{SM}	Repetitive; pulse width limited by T _{JM}			48 A
V _{SD}	I _F =I _S , V _{GS} =0 V, Pulse test, t ≤ 300μs, duty cycle ≤2%			1.5 V
T _{rr}			200	ns

CAUTION: Operation at or above the Maximum Ratings values may impact device reliability or cause permanent damage to the device.

Information in this document is believed to be accurate and reliable. IXYSRF reserves the right to make changes to information published in this document at any time and without notice.

IXYS RF reserves the right to change limits, test conditions and dimensions.

IXYS RF MOSFETS are covered by one or more of the following U.S. patents:

4,835,592	4,860,072	4,881,106	4,891,686	4,931,844	5,017,508
5,034,796	5,049,961	5,063,307	5,187,117	5,237,481	5,486,715
5,381,025	5,640,045	6,404,065	6,583,505	6,710,463	6,727,585
6,731,002					

Fig. 1 Gate Charge vs. Gate-to-Source Voltage
 $V_{DS} = 600V, I_D = 4A, I_G = 3mA$

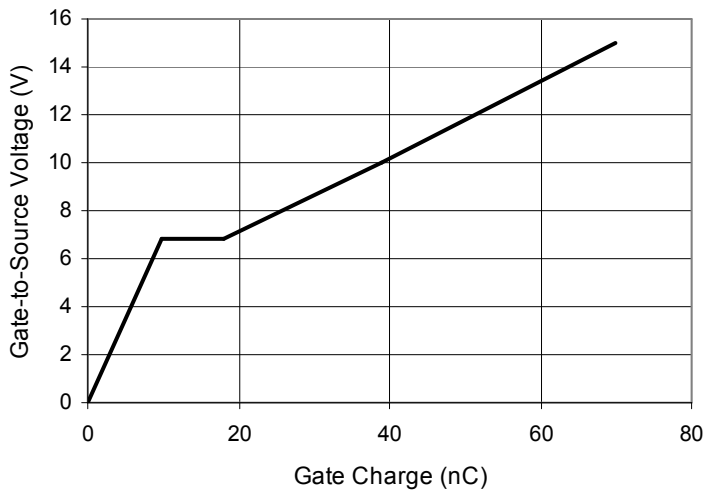


Fig. 2 Typical Output Characteristics

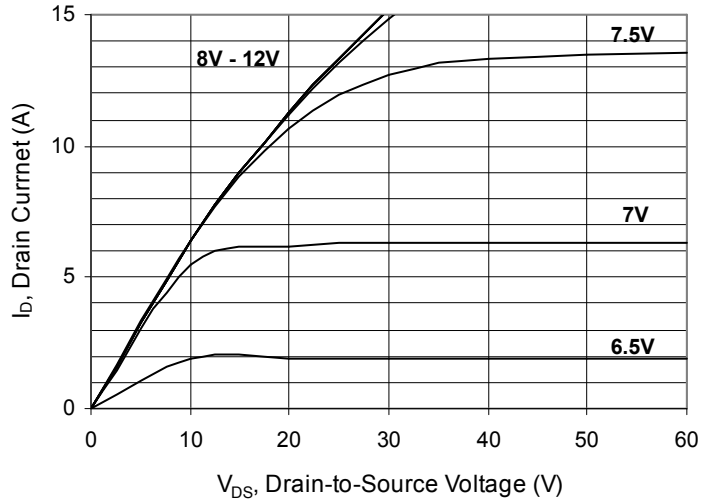


Fig. 3 Typical Transfer Characteristics
 $V_{DS} = 60V, PW = 30\mu s$

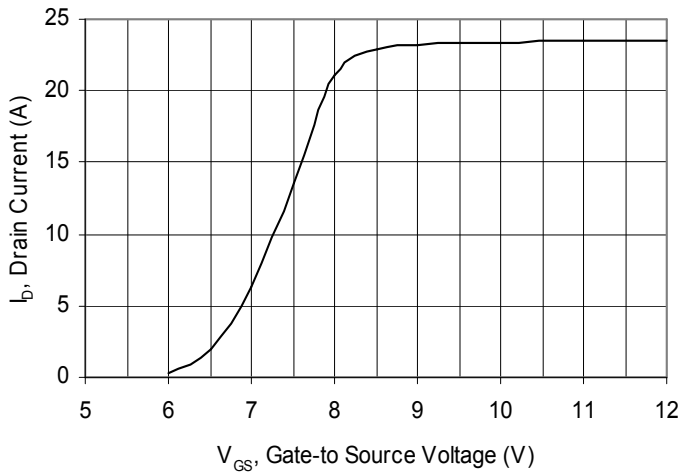


Fig. 4 Extended Typical Output Characteristics

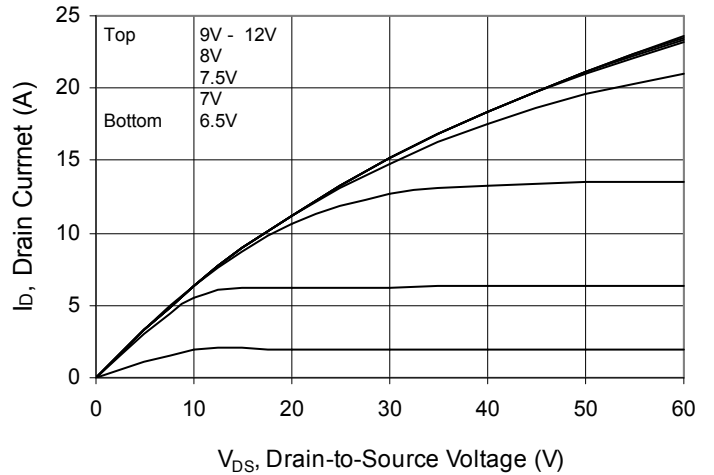


Fig. 5 V_{DS} vs. Capacitance

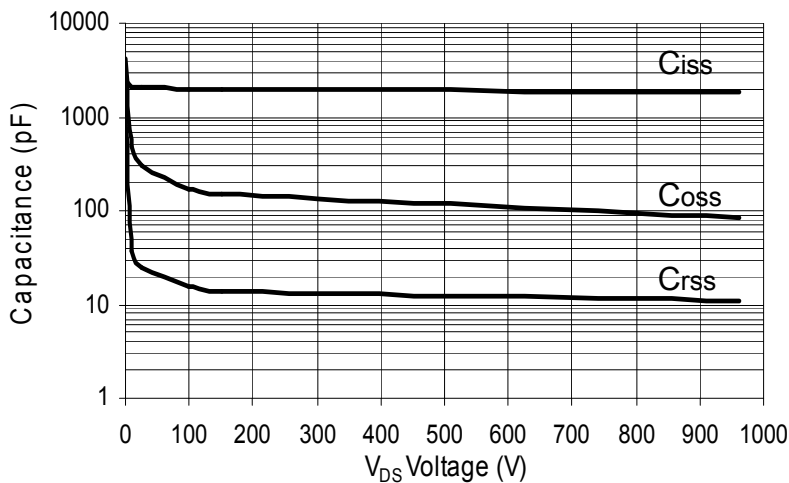
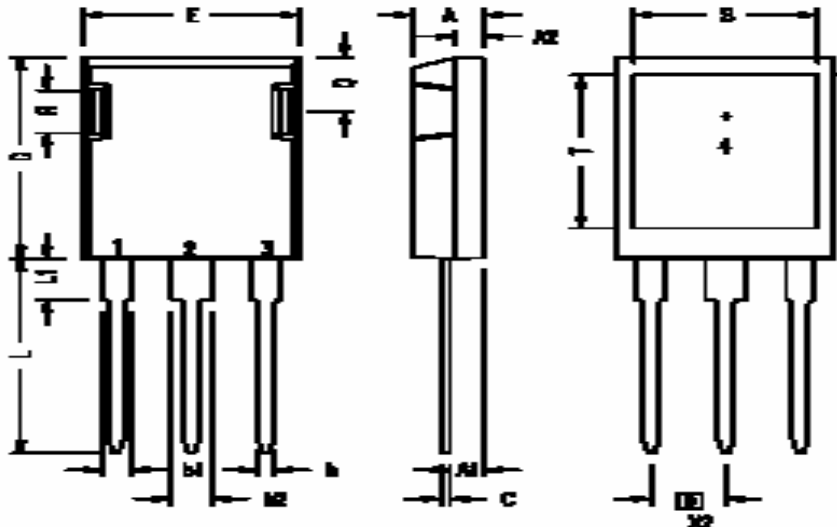
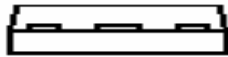


Fig. 6 Package Drawing

ISOPLUS 247 OUTLINE



120: 1=G, 2=D, 3=S
 120A: 1=G, 2=S, 3= D
 120B: 1=D, 2=S, 3=G



1 Gate, 2 Drain (Collector)
 3 Source (Emitter)
 4 no connection

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.83	5.21	.190	.205
A ₁	2.29	2.54	.090	.100
A ₂	1.91	2.16	.075	.085
b	1.14	1.40	.045	.055
b ₁	1.91	2.13	.075	.084
b ₂	2.92	3.12	.115	.123
C	0.61	0.80	.024	.031
D	20.80	21.34	.819	.840
E	15.75	16.13	.620	.635
e	5.45 BSC		.215 BSC	
L	19.81	20.32	.780	.800
L1	3.81	4.32	.150	.170
Q	5.59	6.20	.220	.244
R	4.32	4.83	.170	.190

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